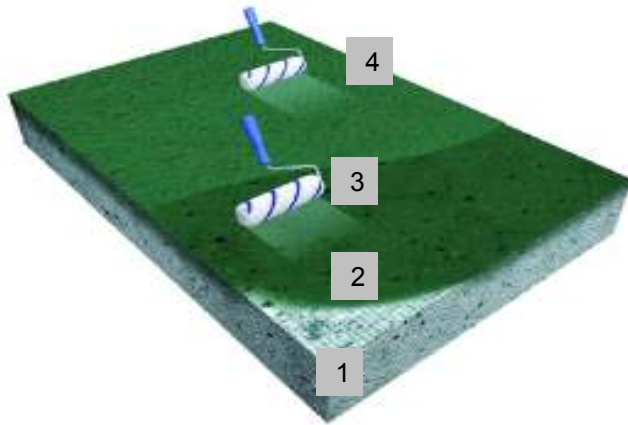




# Oil and Damp Tolerant Priming System

FeRFA Type 3 System  
DFT = 600 μ



1. Surface preparation by suitable mechanical means.
2. Application of suitably selected primer e.g. Epoxy MT 100 or Epoxy FAS 100.
3. Application of second coat of the same primer applied at 90° to the first application to reduce pin-holing.
4. Optional broadcasting with quartz sand to the final layer to give adhesion of e.g. subsequent polymer cement screeds such as Optiplan or Multiplan.

### System Properties:

- Damp tolerant <6%
- Tolerant of certain oils
- Moisture barrier
- Extra security
- Clear
- Fast curing
- Solvent free
- Excellent adhesion to difficult surfaces

### Typical Environment

	Light Loads	✓
	Moderate Loads	✓
	Increased Loads	✓
	Heavy Loads	✓

### Suitable for Surfaces

Oily surfaces which have been burnt	
Oily surfaces which have been cleaned	
Milled or planed cementitious floors	
Cementitious floors prepared by ball blasting	
Always conduct a trial area.	





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Item	Operation	Material / m <sup>2</sup>	Price / m <sup>2</sup>
1	<b>Surface Preparation</b> The substrate shall be prepared by suitable means to remove all contaminants and weakness to give a clean, sound load-bearing surface. If over coating an existing finish a trial shall be conducted to assess bond.		
2	<b>Priming</b> The prepared substrate is primed with a suitably selected primer e.g. Epoxy MT100 or Epoxy FAS 100, by squeegee and back roller.	0.35 - 0.5 kg/m <sup>2</sup>	
3	<b>Priming</b> A second coat of the same primer is applied at 90° to the first application, by squeegee and back roller.	0.35 - 0.5 kg/m <sup>2</sup>	
4	<b>Broadcasting</b> Optional full blinding of the second primer with quartz sand to give adhesion to subsequent PCC layer.	2 - 3 kg/m <sup>2</sup>	
<b>Total</b>			

**Notes:** Application rates and coverage are theoretical and do not allow for surface profile variation, wastage or variation in application technique. In the case of high substrate roughness you should allow for additional levelling material to be used.